



NOTES:
 1. PACKAGE CONFORMS TO JEDEC MS-001, VARIATION BB.
 2. DIM AND TOL CONFORM TO ASME Y14.5-2009.
 3. ALL DIM ARE IN INCHES.
 4. D AND E1 DIMENSIONS FOR PLASTIC PACKAGES DO NOT INCLUDE MOLD FLASH OF PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH.

SYMBOL	MIN	MAX	SYMBOL	MIN	MAX
A	-	0.210	E	0.300	0.325
A1	0.015	-	E1	0.240	0.280
A2	0.115	0.195	eB	0.345	0.365
A3	0.06 REF		L	0.115	0.200
b	0.014	0.022			
b2	0.045	0.070			
D	0.735	0.775			
D1	0.005	-			
e	0.100 BSC				



TITLE		REV A
16 LEAD PDIP-300 mils		
DWG. NO.: 16 Lead PDIP-300		SHEET 1 of 1
DO NOT SCALE	File Name: 16-Lead-PDIP-300.PDF	

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